

MOS FIELD EFFECT TRANSISTOR $\mu PA1716$

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is P-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

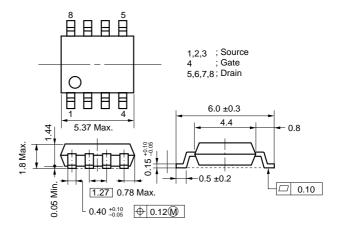
FEATURES

- Low on-resistance
- $\begin{array}{l} R_{DS(on)1} = 12.5 \mbox{ m}\Omega \mbox{ TYP.} \ (V_{GS} = -10 \mbox{ V}, \mbox{ Id} = -4 \mbox{ A}) \\ R_{DS(on)2} = 17.0 \mbox{ m}\Omega \mbox{ TYP.} \ (V_{GS} = -4.5 \mbox{ V}, \mbox{ Id} = -4 \mbox{ A}) \\ R_{DS(on)3} = 19.0 \mbox{ m}\Omega \mbox{ TYP.} \ (V_{GS} = -4.0 \mbox{ V}, \mbox{ Id} = -4 \mbox{ A}) \end{array}$
- Low Ciss : Ciss = 2100 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1716G	Power SOP8

PACKAGE DRAWING (Unit : mm)



EQUIVARENT CIRCUIT

Drain to Source Voltage (Vgs = 0 V) VDSS -30 V Drain Gate to Source Voltage (VDS = 0 V) VGSS **∓**20 V Body Drain Current (DC) ∓8 ID(DC) А ¥. н Gate Diode Drain Current (pulse) Note1 **∓**32 D(pulse) Α Total Power Dissipation (T_A = 25° C) ^{Note2} Pτ 2.0 W Gate **Channel Temperature** Tch 150 °C Protection Source Diode Storage Temperature °C Tstg -55 to +150

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

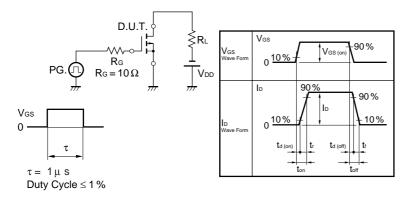
- 2. Mounted on ceramic substrate of 1200 mm² x 1.0 mm
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

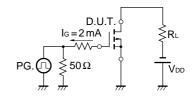
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = -10 V, Ib = -4.0 A		12.5	16	mΩ
	RDS(on)2	$V_{GS} = -4.5 \text{ V}, \text{ Id} = -4.0 \text{ A}$		17	23	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -4.0 \text{ A}$		19	26	mΩ
Gate to Source Cut-off Voltage	VGS(off)	$V_{DS} = -10 V, I_{D} = -1 mA$	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	yfs	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -4.0 \text{ A}$	7	14		S
Drain Leakage Current	IDSS	Vds = -30 V, VGs = 0 V			-1	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓ 10	μΑ
Input Capacitance	Ciss	$V_{DS} = -10 V$		2100		pF
Output Capacitance	Coss	Vgs = 0 V		700		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		300		pF
Turn-on Delay Time	td(on)	ID = -4.0 A		30		ns
Rise Time	tr	$V_{GS(on)} = -10 V$		150		ns
Turn-off Delay Time	td(off)	$V_{DD} = -15 V$		120		ns
Fall Time	tr	$R_G = 10 \Omega$		76		ns
Total Gate Charge	QG	ID = -8.0 A		40		nC
Gate to Source Charge	Q _{GS}	$V_{DD} = -24 V$		6		nC
Gate to Drain Charge	Qgd	$V_{GS} = -10 V$		10		nC
Body Diode Forward Voltage	VF(S-D)	IF = 8.0 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 8.0 A, VGS = 0 V		45		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μ s		33		nC

ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

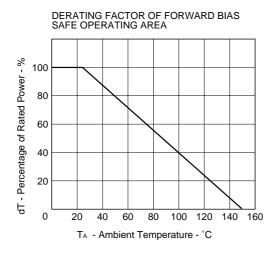
TEST CIRCUIT 1 SWITCHING TIME

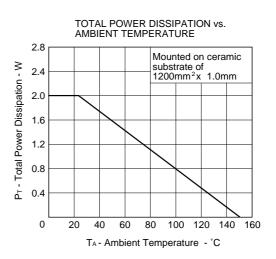


TEST CIRCUIT 2 GATE CHARGE

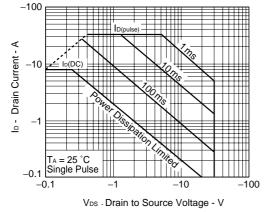


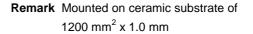
TYPICAL CHARACTERISTICS (TA = 25 °C)

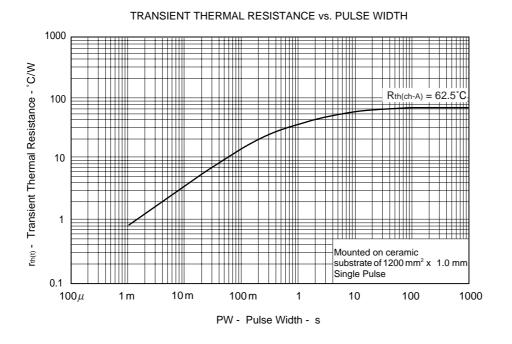






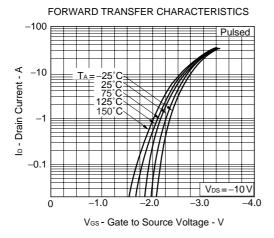




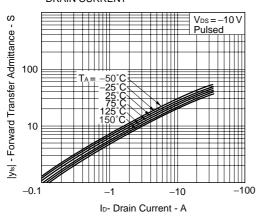


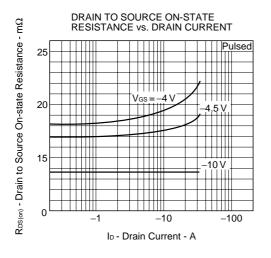
Data Sheet G13727EJ1V0DS00

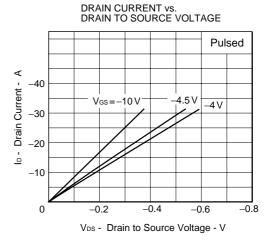




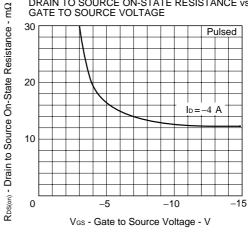




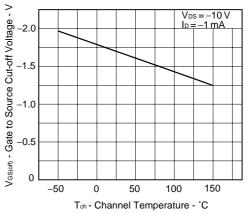




DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

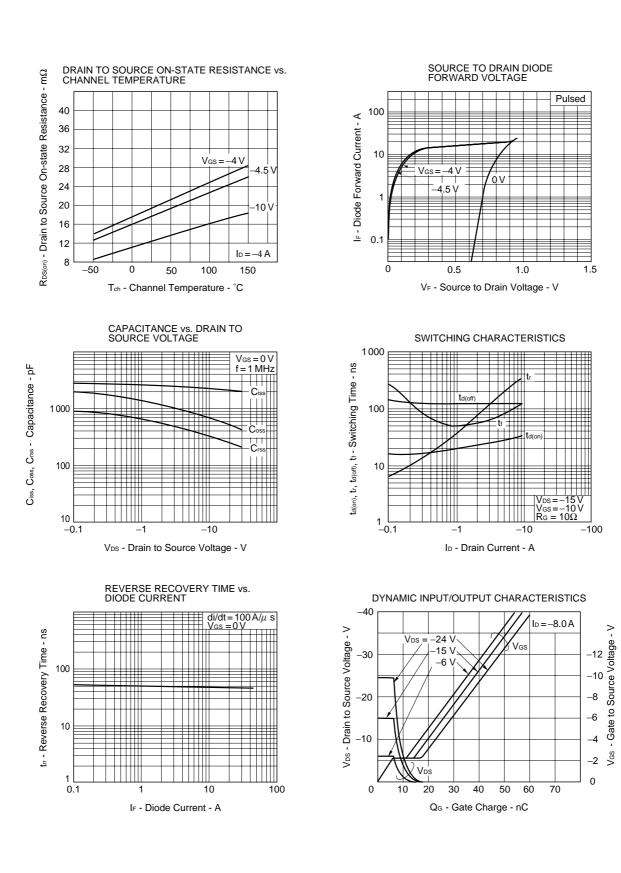


GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



Data Sheet G13727EJ1V0DS00

NEC



NEC

[MEMO]

NEC

[MEMO]

• The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.
- NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property
 rights of third parties by or arising from use of a device described herein or any other liability arising from use
 of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other
 intellectual property rights of NEC Corporation or others.
- Descriptions of circuits, software, and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software, and information in the design of the customer's equipment shall be done under the full responsibility of the customer. NEC Corporation assumes no responsibility for any losses incurred by the customer or third parties arising from the use of these circuits, software, and information.
- While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.
- NEC devices are classified into the following three quality grades:
 "Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.
 - Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.